

05.2020

Micro OLED 0.84" - 96x16 dots

Incl. controller SSD1306B



Features

- 0.84" Low-Power OLED
- -40..+80°C (T_{op.})
- 96x16 dots
- Bright white content with unlimited viewing angle
- Incl. controller SSD1306B
- I²C-Bus Interface
- Fast response time (10μs) even at -40°C
- Connection by stamp soldering

Ordering code

OLED 0.84" - 96x16 dots, white

EA W096016-XALW

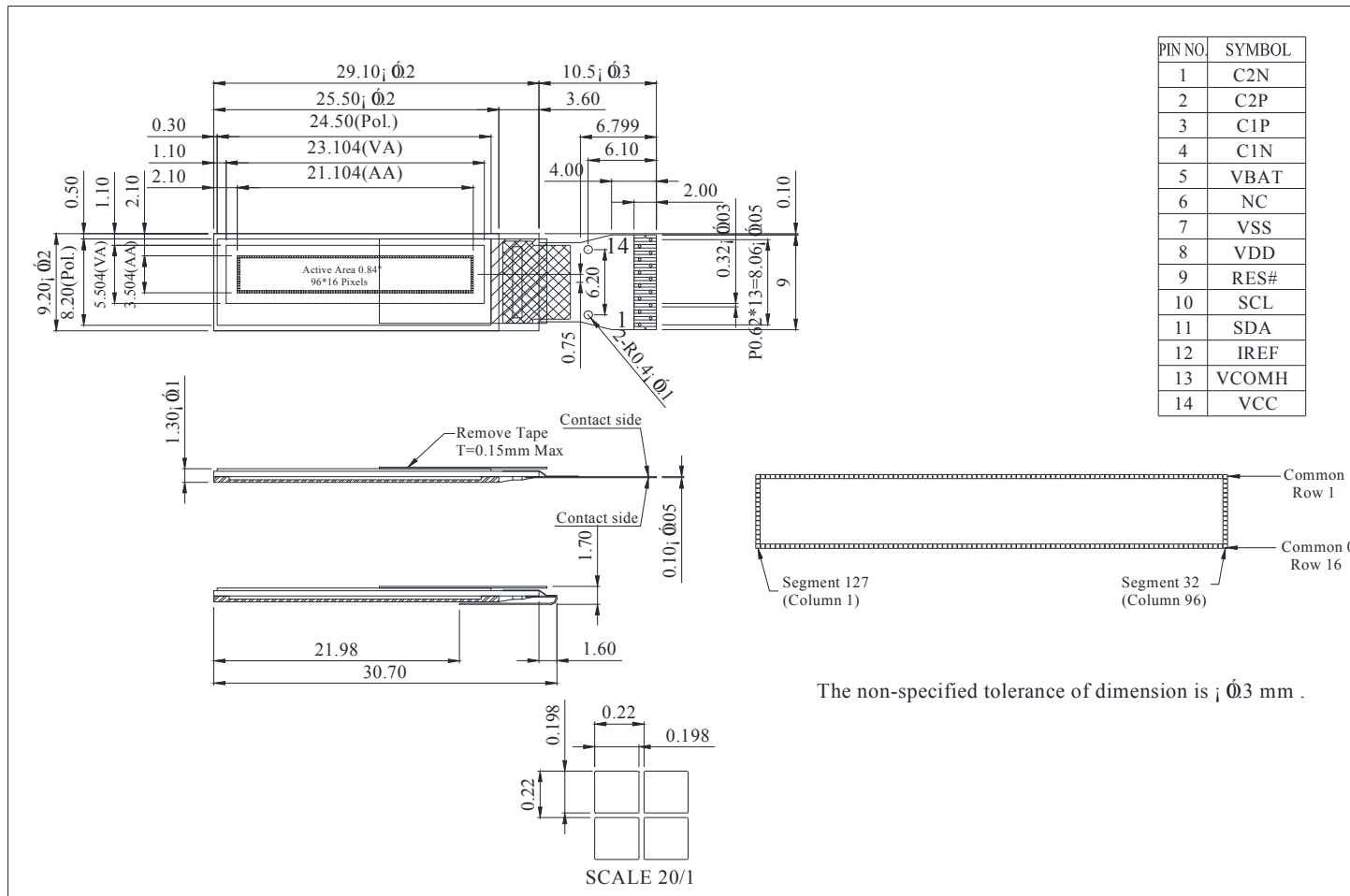
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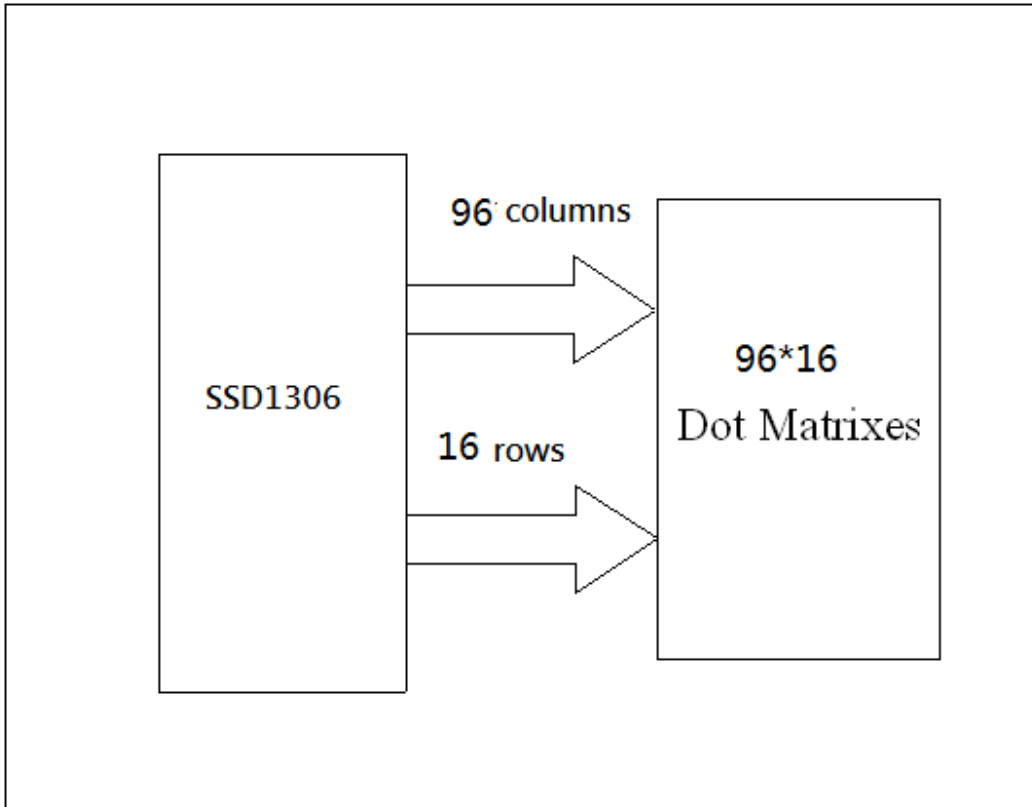
1. General Specification

Item	Dimension	Unit
Dot Matrix	96 x 16 Dots	—
Module dimension	29.1 × 9.2 × 1.3	mm
Active Area	21.104 × 3.504	mm
Pixel Size	0.198 × 0.198	mm
Pixel Pitch	0.220 × 0.220	mm
Display Mode	Passive Matrix	
Display Color	White (EA W096016-XALW)	
Drive Duty	1/16Duty	
IC	SSD1306BZ	

2. Contour Drawing & Block Diagram



FUNCTION BLOCK DIAGRAM



3. Interface Pin Function

FPC cable is for direct soldering to pcb. Soldering process is stamp soldering. Note that there's no connector available.

No.	Symbol	Function
1	C2N	<i>Positive Terminal of the Flying Inverting Capacitor or Negative Terminal of the Flying Boost Capacitor</i> The charge-pump capacitors are required between the terminals. They must be floated when the converter is not used.
2	C2P	
3	C1P	
4	C1N	
5	VBAT	<i>Power Supply for DC/DC Converter Circuit</i> This is the power supply pin for the internal buffer of the DC/DC voltage converter. It must be connected to external source when the converter is used. It should be connected to VDD when the converter is not used.
6	NC	No connection
7	VSS	<i>Ground of Logic Circuit</i> This is a ground pin. It acts as a reference for the logic pins. It must be connected to external ground.
8	VDD	<i>Power Supply for Logic</i> This is a voltage supply pin. It must be connected to external source.
9	RES#	<i>Power Reset for Controller and Driver</i> This pin is reset signal input. When the pin is low, initialization of the chip is executed.
10	SCL	<i>I2C mode is selected, D2, D1 should be tied together and serve as SDAout, SDAin in application and D0 is the serial clock input, SCL.</i>
11	SDA	
12	IREF	<i>Current Reference for Brightness Adjustment</i> This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 12.5µA.
13	VCOMH	<i>Voltage Output High Level for COM Signal</i> This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
14	VCC	<i>Power Supply for OEL Panel</i> This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and VSS when the converter is used. It must be connected to external source when the converter is not used.



**ELECTRONIC
ASSEMBLY**
new display design

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4. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	0	4	V	1,2
Supply Voltage for Display	VCC	0	16	V	1,2
Operating Temperature	TOP	-40	+80	°C	—
Storage Temperature	TSTG	-40	+80	°C	—

Note 1: All the above voltages are on the basis of “VSS = 0V”.

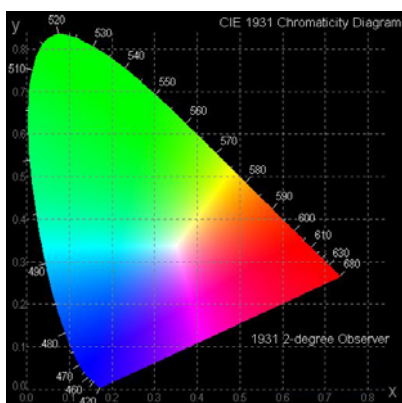
Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6. “Optics & Electrical Characteristics”. If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

5. Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage for Logic	VDD	—	2.8	3.0	3.3	V
Supply Voltage for Display (Supplied Externally)	VCC	—	7.0	7.5	7.8	V
Charge Pump Regulator Supply Voltage	VBAT	—	3.3	—	4.2	V
Charge Pump Output Voltage for Display (Generated by Internal DC/DC)	Charge Pump VCC	—	7.0	7.5	7.8	V
Input High Volt.	VIH	—	0.8×VDD	—	VDD	V
Input Low Volt.	VIL	—	0	—	0.2×VDD	V
Output High Volt.	VOH	—	0.9×VDD	—	VDD	V
Output Low Volt.	VOL	—	0	—	0.1×VDD	V
50% chessboard pattern operating current (VCC Supplied Externally)	ICC	—	—	7	15	mA
50% chessboard pattern operating current (VCC Generated by Internal DC/DC)	IBAT	—	10	15	25	mA

6. Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) θ		160			deg
	(H) ϕ		160			deg
Contrast Ratio	CR	Dark	2000:1		—	—
Response Time	T rise	—		10		μ s
	T fall	—		10		μ s
Display with 100% Full Screen Brightness (White)			100	120		cd/m ²
Display with 100% Full Screen Brightness (Blue)			120	150		cd/m ²
Display with 100% Full Screen Brightness (Yellow)			120	150		cd/m ²
CIEx (White)		(CIE1931)	0.26	0.28	0.30	
CIEy (White)		(CIE1931)	0.30	0.32	0.34	
CIEx (Blue)		(CIE1931)	0.12	0.16	0.20	
CIEy (Blue)		(CIE1931)	0.22	0.26	0.30	
CIEx (Yellow)		(CIE1931)	0.45	0.47	0.49	
CIEy (Yellow)		(CIE1931)	0.48	0.50	0.52	



7. OLED Lifetime


ITEM	Conditions	Min	Typ	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value White color	20,000 Hrs	—	Note
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value Blue color	20,000 Hrs	—	Note
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value Yellow color	50,000 Hrs	—	Note

Notes:

1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
3. Screen saving mode will extend OLED lifetime.

8. Reliability

Content of Reliability Test

Environmental Test			
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80□ 240hrs	—
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40□ 240hrs	—
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80□ 240hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40□ 240hrs	—
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60□,90%RH 240hrs	—
Temperature Cycle	Endurance test applying the low and high temperature cycle. 	-40□/80□ 100 cycles	—
Mechanical Test			
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr	—
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction	—
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	—
Others			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	—

*** Supply voltage for OLED system =Operating voltage at 25°C

Test and measurement conditions

1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at $23\pm 5^{\circ}\text{C}$; $55\pm 15\%$ RH.
2. All-pixels-on is used as operation test pattern.
3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

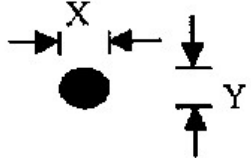
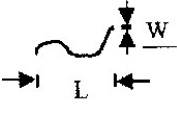
1. The function test is OK.
2. No observable defects.
3. Luminance: $> 50\%$ of initial value.
4. Current consumption: within $\pm 50\%$ of initial value.

APPENDIX:

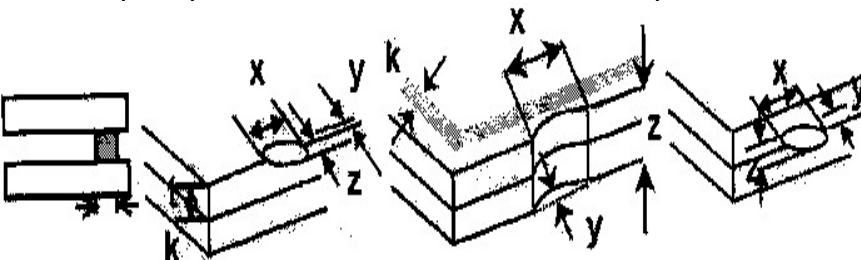
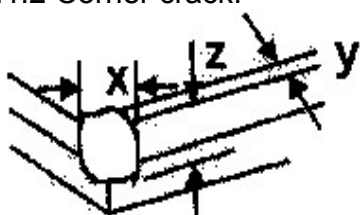
RESIDUE IMAGE

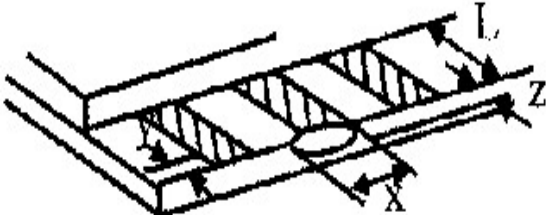
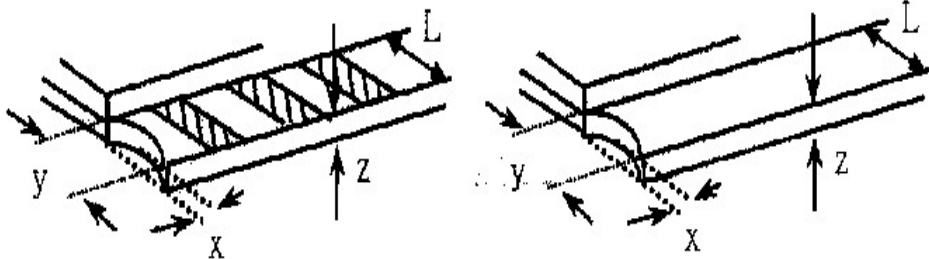
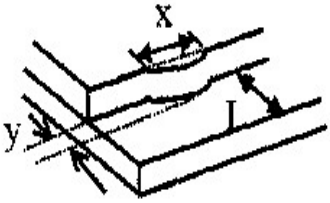
Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

9. Inspection specification

NO	Item	Criterion	AQL														
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.	0.65														
02	Black or white spots on OLED (display only)	2.1 White and black spots on display $\square 0.25\text{mm}$, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm.	2.5														
03	OLED black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $\Phi = (x + y) / 2$  <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>SIZE</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.10$</td> <td>Accept no dense</td> </tr> <tr> <td>$0.10 < \Phi \leq 0.20$</td> <td>2</td> </tr> <tr> <td>$0.20 < \Phi \leq 0.25$</td> <td>1</td> </tr> <tr> <td>$0.25 < \Phi$</td> <td>0</td> </tr> </tbody> </table>	SIZE	Acceptable Q TY	$\Phi \leq 0.10$	Accept no dense	$0.10 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.25$	1	$0.25 < \Phi$	0	2.5				
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		3.2 Line type : (As following drawing)  <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>Length</th> <th>Width</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td>---</td> <td>$W \leq 0.02$</td> <td>Accept no dense</td> </tr> <tr> <td>$L \leq 3.0$</td> <td>$0.02 < W \leq 0.03$</td> <td rowspan="2">2</td> </tr> <tr> <td>$L \leq 2.5$</td> <td>$0.03 < W \leq 0.05$</td> </tr> <tr> <td>---</td> <td>$0.05 < W$</td> <td>As round type</td> </tr> </tbody> </table>	Length	Width	Acceptable Q TY	---	$W \leq 0.02$	Accept no dense	$L \leq 3.0$	$0.02 < W \leq 0.03$	2	$L \leq 2.5$	$0.03 < W \leq 0.05$	---	$0.05 < W$	As round type	2.5
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04	Polarizer bubbles	<table border="1" style="margin-left: 20px;"> <thead> <tr> <th>Size Φ</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.20$</td> <td>Accept no dense</td> </tr> <tr> <td>$0.20 < \Phi \leq 0.50$</td> <td>3</td> </tr> <tr> <td>$0.50 < \Phi \leq 1.00$</td> <td>2</td> </tr> <tr> <td>$1.00 < \Phi$</td> <td>0</td> </tr> </tbody> </table>	Size Φ	Acceptable Q TY	$\Phi \leq 0.20$	Accept no dense	$0.20 < \Phi \leq 0.50$	3	$0.50 < \Phi \leq 1.00$	2	$1.00 < \Phi$	0	2.5				
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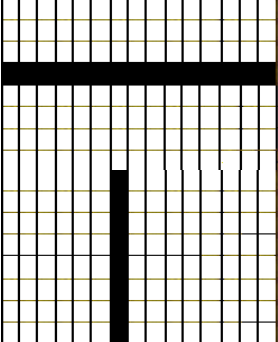
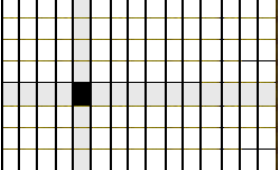
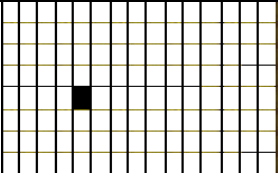
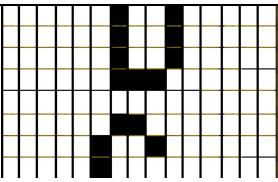
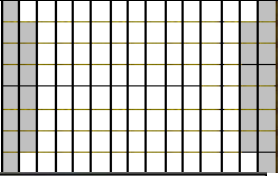









			Total Q TY	3	
<p>If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.</p>					

NO	Item	Criterion	AQL																		
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination																			
06	Chipped glass	<p>Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length:</p> <p>6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels:</p>  <table border="1"> <tr> <td>z: Chip thickness</td> <td>y: Chip width</td> <td>x: Chip length</td> </tr> <tr> <td>$Z \leq 1/2t$</td> <td>Not over viewing area</td> <td>$x \leq 1/8a$</td> </tr> <tr> <td>$1/2t < z \leq 2t$</td> <td>Not exceed 1/3k</td> <td>$x \leq 1/8a$</td> </tr> </table> <p>⊙ If there are 2 or more chips, x is total length of each chip.</p> <p>6.1.2 Corner crack:</p>  <table border="1"> <tr> <td>z: Chip thickness</td> <td>y: Chip width</td> <td>x: Chip length</td> </tr> <tr> <td>$Z \leq 1/2t$</td> <td>Not over viewing area</td> <td>$x \leq 1/8a$</td> </tr> <tr> <td>$1/2t < z \leq 2t$</td> <td>Not exceed 1/3k</td> <td>$x \leq 1/8a$</td> </tr> </table> <p>⊙ If there are 2 or more chips, x is the total length of each chip.</p>	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	2.5
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06	Glass crack	<p>Symbols :</p> <p>x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length</p> <p>6.2 Protrusion over terminal :</p> <p>6.2.1 Chip on electrode pad :</p>  <table border="1" data-bbox="331 969 1217 1048"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td>$y \leq 0.5\text{mm}$</td> <td>$x \leq 1/8a$</td> <td>$0 < z \leq t$</td> </tr> </table> <p>6.2.2 Non-conductive portion:</p>  <table border="1" data-bbox="400 1368 1217 1480"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td>$y \leq L$</td> <td>$x \leq 1/8a$</td> <td>$0 < z \leq t$</td> </tr> </table> <p>⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</p> <p>⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged.</p> <p>6.2.3 Substrate protuberance and internal crack.</p>  <table border="1" data-bbox="727 1720 1222 1798"> <tr> <td>y: width</td> <td>x: length</td> </tr> <tr> <td>$y \leq 1/3L$</td> <td>$x \leq a$</td> </tr> </table>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$	y: Chip width	x: Chip length	z: Chip thickness	$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$	y: width	x: length	$y \leq 1/3L$	$x \leq a$	2.5
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NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB, COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5 2.5 0.65 2.5 2.5 0.65 0.65 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.	2.5
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 OLED pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.65

Check Item	Classification	Criteria									
No Display	Major										
Missing Line	Major										
Pixel Short	Major										
Darker Short	Major										
Wrong Display	Major										
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	 <div data-bbox="863 1742 1139 1937" style="border: 1px solid black; padding: 5px; margin-top: 10px;"> <table style="border-collapse: collapse;"> <tr> <td style="padding: 2px;">A</td> <td style="padding: 2px;"></td> <td style="padding: 2px;">Normal</td> </tr> <tr> <td style="padding: 2px;">B</td> <td style="padding: 2px;"></td> <td style="padding: 2px;">Dark Pixel</td> </tr> <tr> <td style="padding: 2px;">C</td> <td style="padding: 2px;"></td> <td style="padding: 2px;">Light Pixel</td> </tr> </table> </div>	A		Normal	B		Dark Pixel	C		Light Pixel
A		Normal									
B		Dark Pixel									
C		Light Pixel									

10. Precautions in use of OLED Modules

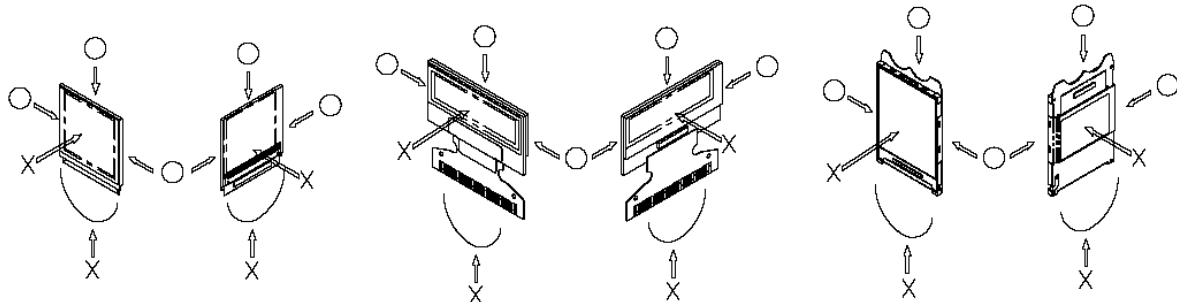
Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist OLED display module.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9) Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10) ELECTRONIC ASSEMBLY has the right to change the passive components, including R2 and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) ELECTRONIC ASSEMBLY have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, ELECTRONIC ASSEMBLY have the right to modify the version.)

10.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalentNever try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the polarizer:
 - * Water
 - * Ketone
 - * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the

System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OLED display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.
 - * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protectivefilm.
- (11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

10.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from ELECTRONIC ASSEMBLY.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under

high humidity environments, the electrodes may be corroded and be careful about the above.

10.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.

* Connection (contact) to any other potential than the above may lead to rupture of the IC.

10.4. Precautions when disposing of the OLED display modules

- 1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

10.5. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.

Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.

* Pins and electrodes

* Pattern layouts such as the TCP & FPC

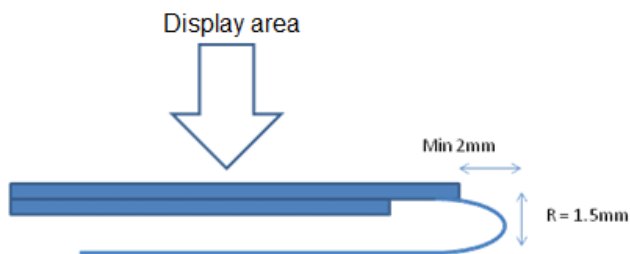
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.

* Design the product and installation method so that the OLED driver may be shielded from light in actual usage.

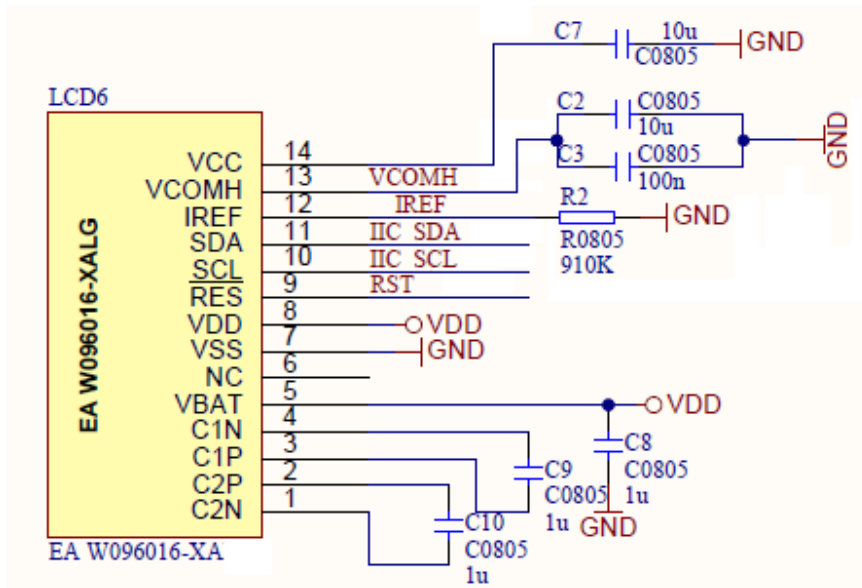
* Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.

- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.

- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6) Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7) Our company will has the right to upgrade and modify the product function.
- (8) The limitation of FPC bending



11. Application example



12. Initialization example

```

/*****
Global variables and defines
*****/

#define I2CADDRESS 0x3c

uint8_t buf[2];           //I2C buffer
uint8_t buffer[193];     //data buffer

/*****
Function name: sendcommand
Description: Sends a command byte via I2C
*****/

void sendcommand(uint8_t byte){
    uint16_t adr = I2CADDRESS;    //I2C address 0x3C
    uint8_t i = 0;
    waitforemptybuffer();        //waits until I2C output buffer is empty

    //control byte //initialization byte
    //  |           |
    buf[i++] = 0x00; buf[i++] = byte;

    R_RIIC0_Master_Send(adr,buf,2);    //send buffer via I2C
}

/*****
Function name: initW096016
Description: Initialization of the display
*****/

void initW096016(void){
    PORT5.PODR.BIT.B4 = 0;        //D/C# pin low

    PORT5.PODR.BIT.B5 = 0;        //reset pin low
    ms_delay(100);                //100ms delay
    PORT5.PODR.BIT.B5 = 1;        //reset pin high
    ms_delay(100);                //100ms delay

    sendcommand(0xA8);            //set multiplex ratio...
    sendcommand(0x0F);            //...to 16-1
    sendcommand(0x8D);            //charge pump setting...
    sendcommand(0x14);            //...Enable charge pump
    sendcommand(0xDA);            //set COM pins hardware configuration...
    sendcommand(0x02);            //...to sequential COM pin configuration
    sendcommand(0xAF);            //set display on
    sendcommand(0xC8);            //set COM output direction (remap)
    sendcommand(0xA1);            //set segment remap (col. 127 to SEG0)
}

```

```

/*****
Function name: initWindow
Description: Initialization of the window in horizontal addressing mode
*****/

void initWindow(uint8_t startcol, uint8_t stopcol, uint8_t startpage, uint8_t stoppage){

    sendcommand(0x20);        //set memory addressing mode ...
    sendcommand(0x00);        //... to horizontal addressing mode
    sendcommand(0x21);        //set column address
    sendcommand(startcol);    //start column
    sendcommand(stopcol);     //stop column
    sendcommand(0x22);        //set page address
    sendcommand(4+startpage); //start page
    sendcommand(4+stoppage);  //stop page

}

/*****
Function name: sendDataW096016
Description: Sends data to the display (Initialization of the window before sending data to
the display -> initWindow())
*****/

void sendDataW096016(const uint8_t *tx_buf, uint16_t tx_num){
    uint16_t adr = I2CADDRESS; //I2C address 0x3C
    uint16_t i;

    buffer[0] = 0x40;        //control byte (send data)

    for(i=0;i<tx_num;i++){
        buffer[i+1] = tx_buf[i];
    }

    waitforemptybuffer();
    R_RIIC0_Master_Send(adr,buffer,tx_num+1); //send data via I2C
}

```



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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